Unit: mm

TOSHIBA Photocoupler GaAlAs Ired & Photo IC

TLP559(IGM)

Transistor Inverters
Air Conditioner Inverters
Line Receivers
Intelligent Power Modules (IPMs) Interfaces

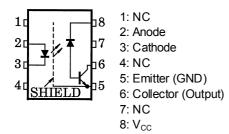
The TOSHIBA TLP559(IGM) consists of a high-output GaAlAs light emitting diode optically coupled to a high-speed photodiode with a transistor amplifier.

The TLP559(IGM) has no internal base connection. The Faraday shield in the photodetector chip provides an effective common-mode noise transient immunity.

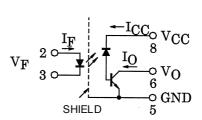
The TLP559(IGM) guarantees minimum and maximum propagation delay time, a relative time difference between the rise and fall time, and common-mode transient immunity. Therefore, the TLP559(IGM) is suitable for an isolation interface between an Intelligent Power Module (IPM) and a control IC in motor control applications.

- Isolation Voltage: 2500 Vrms (min)
- Common-Mode Transient Immunity: ±10 kV/µs (min) @V_{CM} = 1500 V
- Switching Time: t_{pHL} , t_{pLH} = 0.1 μ s (min), = 0.8 μ s (max) @I_F = 10 mA, V_{CC} = 15 V, R_L = 20 $k\Omega$, Ta = 25°C
- Switching Time Dispersion: 0.7 μs (max) (|tpLH-tpHL|)
- TTL Compatible
- UL Recognized: UL1577, File No. E67349

Pin Configuration (Top view)



Schematic





Absolute Maximum Ratings (Ta = 25°C)

| | CHARACTERISTIC | | SYMBOL | RATING | UNIT |
|----------|---|----------|------------------|------------|------|
| | Forward Current | (Note 1) | lF | 25 | mA |
| | Pulse Forward Current | (Note 2) | I _{FP} | 50 | mA |
| LED | Peak Transient Forward Current | (Note 3) | I _{FPT} | 1 | Α |
| | Reverse Voltage | | V _R | 5 | V |
| | Diode Power Dissipation | (Note 4) | P _D | 45 | mW |
| | Output Current | | ΙO | 8 | mA |
| OR | Peak Output Current | | I _{OP} | 16 | mA |
| DETECTOR | Output Voltage | | Vo | -0.5 to 20 | V |
| DET | Supply Voltage | | V _{CC} | -0.5 to 30 | V |
| | Output Power Dissipation | (Note 5) | PO | 100 | mW |
| Оре | Operating Temperature Range | | | -55 to 100 | °C |
| Stor | Storage Temperature Range | | | -55 to 125 | °C |
| Lea | Lead Solder Temperature(10s) (Note 6) | | T _{sol} | 260 | °C |
| Isola | Isolation Voltage(AC, 1 minute, R.H.≤60%, Ta=25°C) (Note 7) | | | 2500 | Vrms |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

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(Note 1) Derate 0.8 mA above 70°C.

(Note 2) 50% duty cycle, 1 ms pulse width.

Derate 1.6 mA/°C above 70°C.

(Note 3) Pulse width PW \leq 1µs, 300 pps.

(Note 4) Derate 0.9 mW/°C above 70°C.

(Note 5) Derate 2 mW/°C above 70°C.

(Note 6) Soldering portion of lead: up to 2mm from the body of the device.

(Note 7) Device considers a two-terminal device : pins 1, 2, 3 and 4 shorted together and pins 5, 6, 7 and 8 shorted together.

Electrical Characteristics (Ta = 25°C)

| CHARACTERISTIC | | SYMBOL | TEST CONDITION | MIN | TYP. | MAX | UNIT |
|----------------|--|----------------------|---|-----|------|------|--------|
| | Forward Voltage | V _F | I _F = 16 mA | _ | 1.65 | 1.85 | V |
| LED | Forward Voltage Temperature Coefficient | ΔV _F /ΔΤα | I _F = 16 mA | _ | -2 | _ | mV /°C |
| | Reverse Current | I _R | V _R = 5 V | _ | _ | 10 | μΑ |
| | Capacitance between Terminal | CT | V = 0, f = 1 MHz | _ | 45 | _ | pF |
| DETECTOR | | I _{OH (1)} | $I_F = 0 \text{ mA}, V_{CC} = V_O = 5.5 \text{ V}$ | _ | 3 | 500 | nA |
| | | I _{OH (2)} | $I_F = 0 \text{ mA}, V_{CC} = 30 \text{ V}$ $V_O = 20 \text{ V}$ | _ | _ | 5 | |
| | | Іон | I _F = 0 mA, V _{CC} = 30 V V _O = 20 V, Ta = 70°C | _ | _ | 50 | μΑ |
| | High Level Supply Voltage | Icch | $I_F = 0 \text{ mA}, V_{CC} = 30 \text{ V}$ — 0.0 | | 0.01 | 1 | μΑ |
| | Supply Voltage | V _{CC} | I _{CC} = 0.01 mA | 30 | _ | _ | V |
| | Output Voltage | Vo | I _O = 0.5 mA | 20 | _ | _ | V |

Coupled Electrical Characteristics (Ta = 25°C)

| CHARACTERISTIC | SYMBOL | TEST CONDITION | MIN | TYP. | MAX | UNIT | |
|--------------------------|-----------------|--|-----|------|-----|------|--|
| Current Transfer Ratio | lo / le | I _F = 10 mA, V _{CC} = 4.5 V V _O = 0.4 V | 25 | 35 | 75 | 0/ | |
| | | I _F = 10 mA, V _{CC} = 4.5 V V _O = 0.4 V, Ta = -25 to 100°C | 15 | _ | _ | % | |
| Low Level Output Voltage | V _{OL} | I _F = 16 mA, V _{CC} = 4.5 V I _O = 2.4 mA | ı | ı | 0.4 | > | |

Isolation Characteristics (Ta = 25°C)

| CHARACTERISTIC | SYMBOL | TEST CONDITION | MIN | TYP. | MAX | UNIT |
|-----------------------------|----------------|---|--------------------|------------------|-----|------|
| Capacitance Input to Output | CS | V = 0, f = 1 MHz (Note 7) | _ | 0.8 | _ | pF |
| Isolation Resistance | R _S | R.H. ≤ 60%, V _S = 500 V (Note 7) | 5×10 ¹⁰ | 10 ¹⁴ | _ | Ω |
| | | AC, 1 minute | 2500 | _ | _ | Vrms |
| Isolation Voltage | BV_S | AC, 1 second, in oil | _ | 5000 | _ | |
| | | DC, 1 minute, in oil | _ | 5000 | - | Vdc |

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Switching Characteristics (Ta = 25°C, V_{CC} = 15 V)

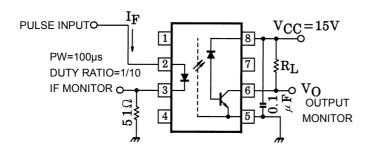
| CHARACTERISTIC | SYMBOL | TEST CIRCUIT | TEST CONDITION | MIN | TYP. | MAX | UNIT |
|---|------------------------------------|--------------------------------------|--|--------|--------|-----|----------|
| Propagation Delay Time (H→L) | | t _{pHL} t _{pLH} | I_F = 10 mA, R_L = 20 kΩ | 0.1 | 0.45 | 0.8 | μs μs |
| | | | I _F = 10 mA, R _L = 20 kΩ Ta = 0~85°C | 0.1 | 0.45 | 0.9 | |
| Propagation Delay Time (L→H) | φιπ | | I _F = 10 mA, R _L = 20 kΩ Ta = -25~100°C | 0.1 | 0.45 | 1.0 | |
| | | 1 | I _F = 10 mA, R _L = 20 kΩ | _ | 0.25 | 0.7 | |
| Switching Time Dispersion between ON and OFF | t _{pLH} -t _{pHL} | | I _F = 10 mA, R _L = 20 kΩ Ta = 0~85°C | _ | 0.25 | 0.8 | |
| | | | I _F = 20 mA, R _L = 20 kΩ Ta = -25~100°C | _ | 0.25 | 0.9 | |
| Common Mode Transient Immunity at Logic High Output (Note 8 | CM _H | 2 | $I_F = 0 \text{ mA},$ $V_{CM} = 1500 V_{p-p,}$ $R_L = 20 \text{ k} \Omega$ | 10000 | 15000 | _ | V /µs |
| Common Mode Transient Immunity at Logic Low Output (Note 8) | CML | | I_F =10 mA, V_{CM} = 1500 V_{p-p} , R_L = 20 k Ω | -10000 | -15000 | | V /µs |

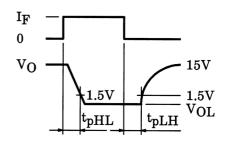
(Note 8) CM_L is the maximum rate of fall of the common mode voltage that can be sustained with the output voltage in the logic low state(Vo<1V).

CM_H is the maximum rate of rise of the common mode voltage that can be sustained with the output voltage in the logic high state(Vo>4V).

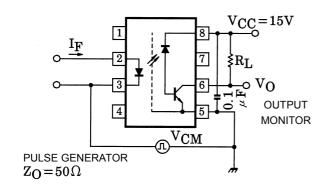
(Note 9) Maximum electrostatic discharge voltage for any pins: 100V(C ≤ 200pF, R=0)

Test Circuit 1: Switching time test circuit

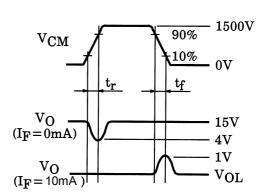




Test Circuit 2: Common mode noise immunity test circuit



$${\rm CM}_{\rm H} = \frac{1200({\rm V})}{{\rm t}_{\rm r}(\mu {\rm s})} \,, \ \ {\rm CM}_{\rm L} = \frac{1200({\rm V})}{{\rm t}_{\rm f}(\mu {\rm s})} \,$$



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